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## FDC6321C Dual N & P Channel , Digital FET

## **General Description**

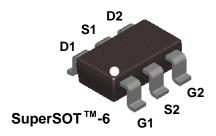
These dual N & P Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors in load switching applications. Since bias resistors are not required this dual digital FET can replace several digital transistors with different bias resistors.

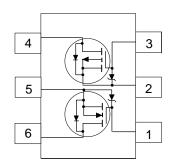
#### **Features**

- N-Ch 25 V, 0.68 A,  $R_{DS(ON)} = 0.45 \Omega$  @  $V_{GS} = 4.5 V$
- P-Ch -25 V, -0.46 A,  $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5 V$ .
- Very low level gate drive requirements allowing direct operation in 3 V circuits. V<sub>GS(th)</sub> < 1.0V.</li>
- Gate-Source Zener for ESD ruggedness.
   >6kV Human Body Model
- Replace multiple dual NPN & PNP digital transistors.



Mark:.321





## **Absolute Maximum Ratings** $T_A = 25^{\circ}\text{C}$ unless other wise noted

Symbol	Parameter	N-Channel	P-Channel	Units
$V_{DSS}, V_{CC}$	Drain-Source Voltage, Power Supply Voltage	25	-25	V
$V_{GSS}, V_{IN}$	Gate-Source Voltage,	8	-8	V
l <sub>D</sub> , l <sub>O</sub>	Drain/Output Current - Continuous	0.68	-0.46	Α
	- Pulsed	2	-1.5	
P <sub>D</sub> Maximum Power Dissipation (Note 1a)		0	W	
	(Note 1b)	0	.7	
$T_J$ , $T_{STG}$	Operating and Storage Tempature Ranger	-55 to	°C	
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)		kV	
THERMA	L CHARACTERISTICS			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	14	°C/W	
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case (Note 1)	6	°C/W	

Symbol	Parameter	Conditions		Гуре	Min	Тур	Max	Units
OFF CHARA	ACTERISTICS	1						I
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	1	N-Ch	25			V
		$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		P-Ch	-25			-
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C		N-Ch		26		mV /°C
555 1		$I_D = -250 \mu\text{A}$ , Referenced to	25 °C I	P-Ch		-22		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, \ V_{GS} = 0 \text{ V},$	ı	N-Ch			1	μA
		T,	_ = 55°C				10	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -20 \text{ V}, \ V_{GS} = 0 \text{ V},$		P-Ch			-1	μA
			<sub>J</sub> = 55°C				-10	
I <sub>GSS</sub>	Gate - Body Leakage Current	$V_{GS} = 8 \text{ V}, \ V_{DS} = 0 \text{ V}$	1	N-Ch			100	nA
		$V_{GS} = -8 \text{ V}, \ V_{DS} = 0 \text{ V}$	ı	P-Ch			-100	nA
ON CHARAC	CTERISTICS (Note 2)		1	,	LI CONTRACTOR OF THE PROPERTY		•	
$\Delta V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to 2	25°C	N-Ch		-2.6		mV/°C
00(11)		$I_D = -250 \mu\text{A}$ , Referenced to	25°C I	P-Ch		2.1		
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	ı	N-Ch	0.65	0.8	1.5	V
		$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	ı	P-Ch	-0.65	-0.86	-1.5	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 0.5 \text{ A}$	ı	N-Ch		0.33	0.45	Ω
		T,	, =125°C			0.51	0.72	
		$V_{GS} = 2.7 \text{ V}, I_{D} = 0.25 \text{A}$				0.44	0.6	
		$V_{GS} = -4.5 \text{ V}, I_{D} = -0.5 \text{ A}$		P-Ch		0.87	1.1	
		T	, =125°C			1.21	1.8	
		$V_{GS} = -2.7 \text{ V}, I_{D} = -0.25 \text{ A}$				1.22	1.5	
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, \ V_{DS} = 5 \text{ V}$	1	N-Ch	1			Α
		$V_{GS} = -4.5 \text{ V}, \ V_{DS} = -5 \text{ V}$	ı	P-Ch	-1			
$g_{FS}$	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 0.5 \text{ A}$	1	N-Ch		1.45		S
		$V_{DS} = -5 \text{ V}, I_{D} = -0.5 \text{ A}$	I	P-Ch		0.8		
DYNAMIC CI	HARACTERISTICS							
C <sub>iss</sub>	Input Capacitance	N-Channel	1	N-Ch		50		pF
		$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$		P-Ch		63		
Coss	Output Capacitance	f = 1.0  MHz		N-Ch		28		pF
		P-Channel		P-Ch		34		
$C_{rss}$	Reverse Transfer Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{V},$		N-Ch		9		pF
		f = 1.0 MHz		P-Ch		10		

# Electrical Characteristics ( $T_A = 25$ °C unless otherwise noted )

## SWITCHING CHARACTERISTICS (Note 2)

Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units	
t <sub>D(on)</sub>	Turn - On Delay Time	N-Channel	N-Ch		3	6	nS	
		$V_{DD} = 6 \text{ V}, I_{D} = 0.5 \text{ A},$	P-Ch		7	20		
t,	Turn - On Rise Time	$V_{Gs} = 4.5 \text{ V}, R_{GEN} = 50 \Omega$	N-Ch		8	16	nS	
			P-Ch		9	18		
t <sub>D(off)</sub>	Turn - Off Delay Time	P-Channel	N-Ch		17	30	nS	
		$V_{DD} = -6 \text{ V}, I_{D} = -0.5 \text{ A},$	P-Ch		55	110		
t,	Turn - Off Fall Time	$V_{Gen}$ = -4.5 V, $R_{GEN}$ = 50 $\Omega$	N-Ch		13	25	nS	
			P-Ch		35	70		
$Q_g$	Total Gate Charge	N-Channel	N-Ch		1.64	2.3	nC	
		$V_{DS} = 5 \text{ V}, I_{D} = 0.5 \text{ A},$	P-Ch		1.1	1.5		
$Q_{gs}$	Gate-Source Charge	V <sub>GS</sub> = 4.5 V	N-Ch		0.38		nC	
		P- Channel	P-Ch		0.32			
$Q_{gd}$	Gate-Drain Charge	$V_{DS} = -5 V$ ,	N-Ch		0.45		nC	
		$I_D = -0.25 \text{ A}, V_{GS} = -4.5 \text{ V}$	P-Ch		0.25			
DRAIN-SC	DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							

I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current			N-Ch		0.3	Α
				P-Ch		-0.5	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 0.5 \text{ A}$ (Note)		N-Ch	0.83	1.2	V
			T <sub>J</sub> =125°C		0.69	0.85	
		$V_{GS} = 0 \text{ V}, I_{S} = -0.5 \text{ A}$ (Note)		P-Ch	-0.89	-1.2	
			T <sub>J</sub> =125°C		-0.75	-0.85	

2. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2.0%.





a. 140°C/W on a 0.125 in² pad of 2oz copper.

b. 180°C/W on a 0.005 in² of pad of 2oz copper.

Notes:

1. R<sub>p,n</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where thecase thermal reference is defined as the solder mounting surface of the drain pins. R<sub>p,ic</sub> is guaranteed by design while R<sub>p,c,n</sub> is determined by the user's board design.

## Typical Electrical Characteristics: N-Channel

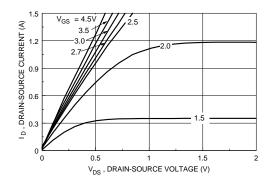


Figure 1. On-Region Characteristics.

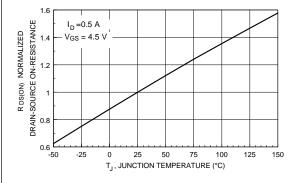


Figure 3. On-Resistance Variation with Temperature.

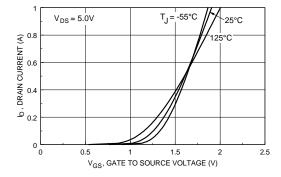


Figure 5. Transfer Characteristics.

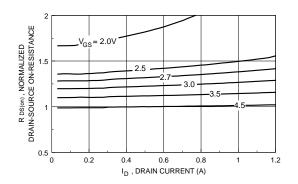


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

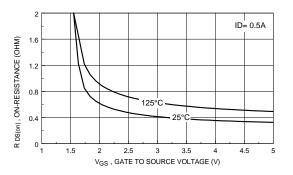


Figure 4. On Resistance Variation with Gate-To-Source Voltage.

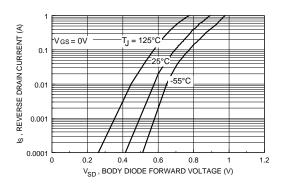


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

## **Typical Electrical Characteristics: N-Channel (continued)**

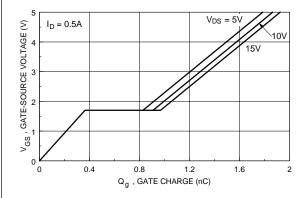


Figure 7. Gate Charge Characteristics.

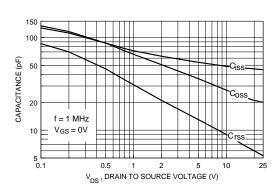


Figure 8. Capacitance Characteristics.

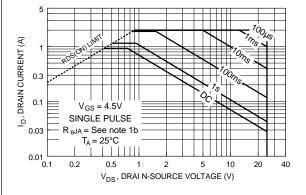


Figure 9. Maximum Safe Operating Area.

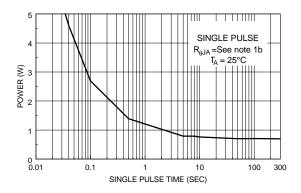


Figure 10. Single Pulse Maximum Power Dissipation.

## **Typical Electrical Characteristics: P-Channel**

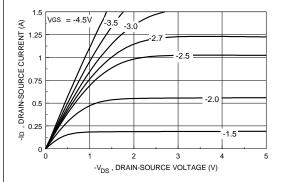


Figure 11. On-Region Characteristics.

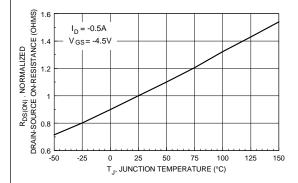


Figure 13. On-Resistance Variation with Temperature.

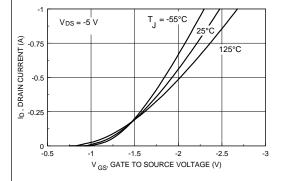


Figure 15. Transfer Characteristics.

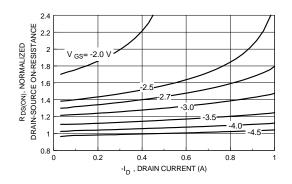


Figure 12. On-Resistance Variation with Drain Current and Gate Voltage.

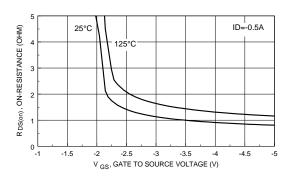


Figure 14. On Resistance Variation with Gate-To- Source Voltage.

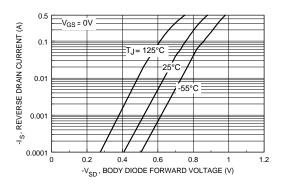
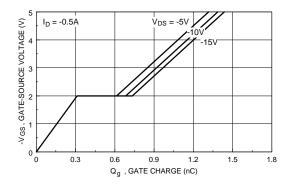


Figure 16. Body Diode Forward Voltage Variation with Source Current and Temperature.

## **Typical Electrical Characteristics: P-Channel (continued)**



CAPACITANCE (pF) 10 = 1 MHz \_V<sub>GS</sub> = 0 V -V  $_{\mathrm{DS}}$ , DRAIN TO SOURCE VOLTAGE (V)

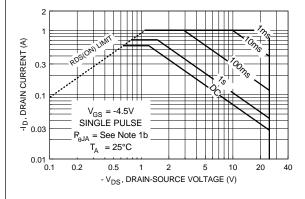
150

100

50

Figure 17. Gate Charge Characteristics.





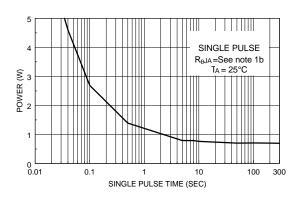


Figure 19. Maximum Safe Operating Area.

Figure 20. Single Pulse Maximum Power Dissipation.

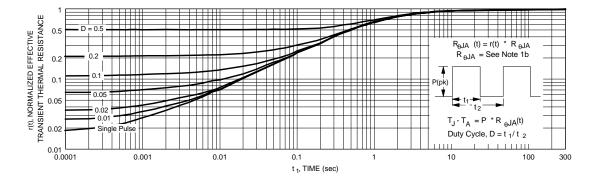


Figure 21. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1b.Transient thermal response will change depending on the circuit board design.

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